RFC Epoxy Damp Proof Membrane is a two-component solvent-free liquid applied surface damp proof membrane and residual moisture suppressant. After curing, Epoxy Damp Proof Membrane provides a surface membrane with excellent adhesion to damp concrete and polymer modified sand/cement screeds. Hygrometer readings up to 98% RH as measured in accordance with BS 8203:2001 can be accommodated. Epoxy Damp Proof Membrane is available in red and yellow as a visual aid for application and coverage.

**Uses**
Epoxy Damp Proof Membrane has been designed for use as a coating over cementitious surfaces which possess high levels of residual moisture or where an integral DPM is not present or not effective. This practice should only be adopted subject to a survey confirming adequate underlying ground stability. Moisture testing should be carried out in accordance with BS 8203.

Epoxy Damp Proof Membrane permits early overlaying with vinyl, carpets and resin based products without the conventional “drying out” period being observed. This product is not suitable for use over under-floor heating systems.

**Thickness**
450 microns (two coat system)

**Typical Properties, 28 days at 20 °C**
- Abrasion resistance (EN 13892-4) AR 0.5
- Abrasion resistance (BS 8204-2) Special Class
- BRE Screed Test Category A
- Adhesive strength to concrete (BS EN 13892-8:2002):
  - Dry concrete > 1.5 MPa
  - 7 day old saturated surface dry concrete 3.2 MPa
- Moisture vapour transfer rate 5 g/m²/day

The typical physical properties given above are derived from testing in a controlled laboratory environment. Results derived from testing field-applied samples may vary dependent upon site conditions.

**Cure Schedule at 20 °C**
- Working life of full packs * 30 minutes

* Usable working life of material following mixing and immediate spreading as per the application instructions.

- Minimum time to overcoat 12 hours
Maximum time to overcoat 48 hours

* The above cure times are approximate and given as a guide only. These times can vary due to prevailing site conditions.

**Surface Preparation**
Inadequate preparation will lead to loss of adhesion and failure. In coatings or flow-applied systems, there is a tendency for the finish to mirror imperfections in the substrate. Grinding or light vacuum contained shot-blasting is therefore preferred over planning where these types of finishes are specified. Percussive scabbling or acid etching is not recommended for any grade of resin flooring.

**Movement Joints**
Movement joints and cracks cannot be bridged with Epoxy Damp Proof Membrane. These should be filled with a flexible jointing material.

**Hydrostatic Pressure**
Hydrostatic pressure may, under certain circumstances, cause adhesive failure between the flooring and the substrate. Where this is likely to occur, such as in areas where the ground water table is higher than the substrate, and where external tanking has not been applied, pressure relief must be provided e.g. by direct drainage.

**Mixing**
Epoxy Damp Proof Membrane is a two-component product. Fully drain the contents of the hardener component into the lightly coloured resin component and mix thoroughly with a slow speed electric stirrer fitted with a spiral paddle, for a minimum of 3 minutes until homogeneous.

**Application Conditions**
Ideal ambient and substrate temperature is 15 - 25 °C to achieve best results. Localised heating or cooling equipment may be required outside these parameters. The substrate and uncured floor must be kept at least 3°C above the dew point to reduce the risk of condensation or blooming on the surface for at least 48 hours after application.